PCN Number:			20180123001			<u> </u>	PCN Date:	January 31,			2018
Title: Datasheet for TS3L501E									2010		
Customer Contact: PCN Manage				jer				Dept:		Quality Services	
Change Type:										,	
		embly Site				Design				Wafer	Bump Site
	Assembly Process			$\boxtimes$	□ Data Sheet     □				Wafer	Bump Material	
	Assembly Materials				Part number change				Wafer Bump Process		
Mechanical Specification				Test Site					Fab Site		
Packing/Shipping/Labeling				Test Process			<u>Ц</u>		Fab Materials		
								Wafer Fab Process			
Notification Details											
Description of Change:											
Texas Instruments Incorporated is announcing an information only notification.											
The product datasheet(s) is being updated as summarized below.  The following change history provides further details.											
The following change history provides further details.											
TEXAS											
INSTRUMENTS  TS3L501E  SCDS307C - SEPTEMBER 2010 - REVISED DECEMBER 2017											
30D33070 - SEFTEMBER 2010-REVISED DECEMBER 2017											
Changes from Revision B (May 2016) to Revision C											
Changes from Revision B (May 2016) to Revision C Page											
•	Added pin numbers 4, 8, 14, 21, 30, 39 to V <sub>DD</sub> in the <i>Pin Functions</i> table										
The datasheet number will be changing.											
Device Family				Change From:				Change To:			
TS3L501E				SCDS307B				SCDS307C			
<b>-</b>	13323012										
These changes may be reviewed at the datasheet links provided.											
http://www.ti.com/product/TS3L501E											
Reason for Change:											
To accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
No anticipated impact. This is a specification change announcement only. There are no changes											
to t	to the actual device.										
Changes to product identification resulting from this PCN:											
Nor	ne.										
Pro	duc	t Affected:									
		1ERUAR									

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com